

設備名稱：充電基座

型號 ( 型式 ) : CCB-H-010BT

Equipment name

Type designation (Type)

單元Unit	限用物質及其化學符號 Restricted substances and its chemical symbols					
	鉛Lead (Pb)	汞Mercury (Hg)	鎘Cadmium (Cd)	六價鉻Hexavalent chromium (Cr+6)	多溴聯苯Polybromi nated biphenyls (PBB)	多溴二苯醚Polybrominat ed diphenyl ethers (PBDE)
印刷電路部件 (PCB)	○	○	○	○	○	○
上蓋 (Top Cover)	○	○	○	○	○	○
下蓋 (Bottom Cover)	-	○	○	○	○	○
連線 (配件) (Cables)	○	○	○	○	○	○
備考1. “超出0.1 wt %” 及 “超出0.01 wt %” 係指限用物質之百分比含量超出百分比含量基準值。 Note 1: “Exceeding 0.1 wt %” and “exceeding 0.01 wt %” indicate that the percentage content of the restricted substance exceeds the reference percentage value of presence condition.						
備考2. “○” 係指該項限用物質之百分比含量未超出百分比含量基準值。 Note 2: “○” indicates that the percentage content of the restricted substance does not exceed the percentage of reference value of presence.						
備考3. “-” 係指該項限用物質為排除項目。 Note 3: The “-” indicates that the restricted substance corresponds to the exemption.						

